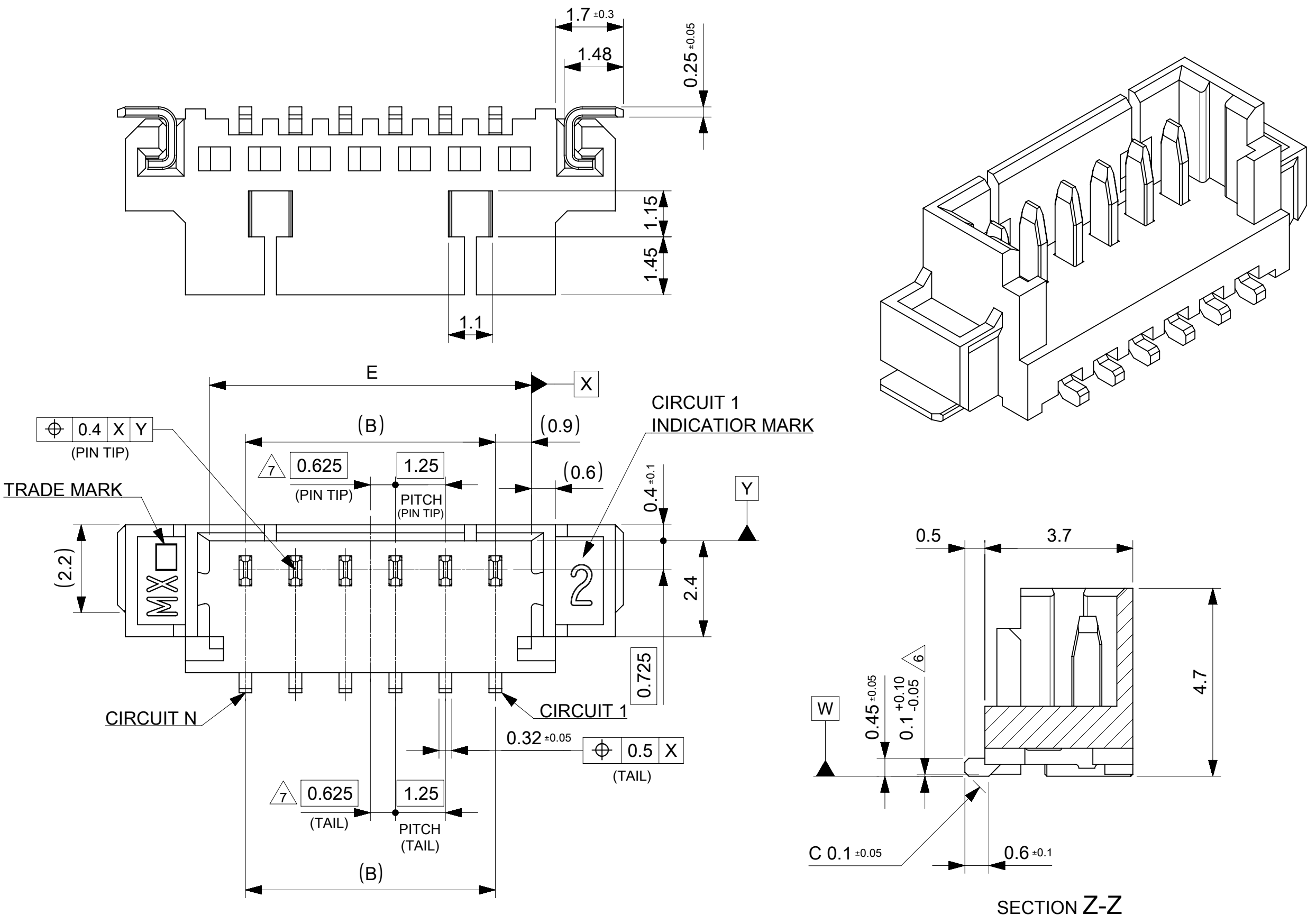
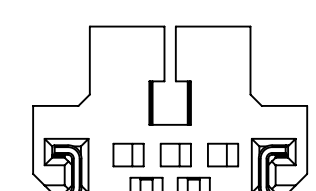
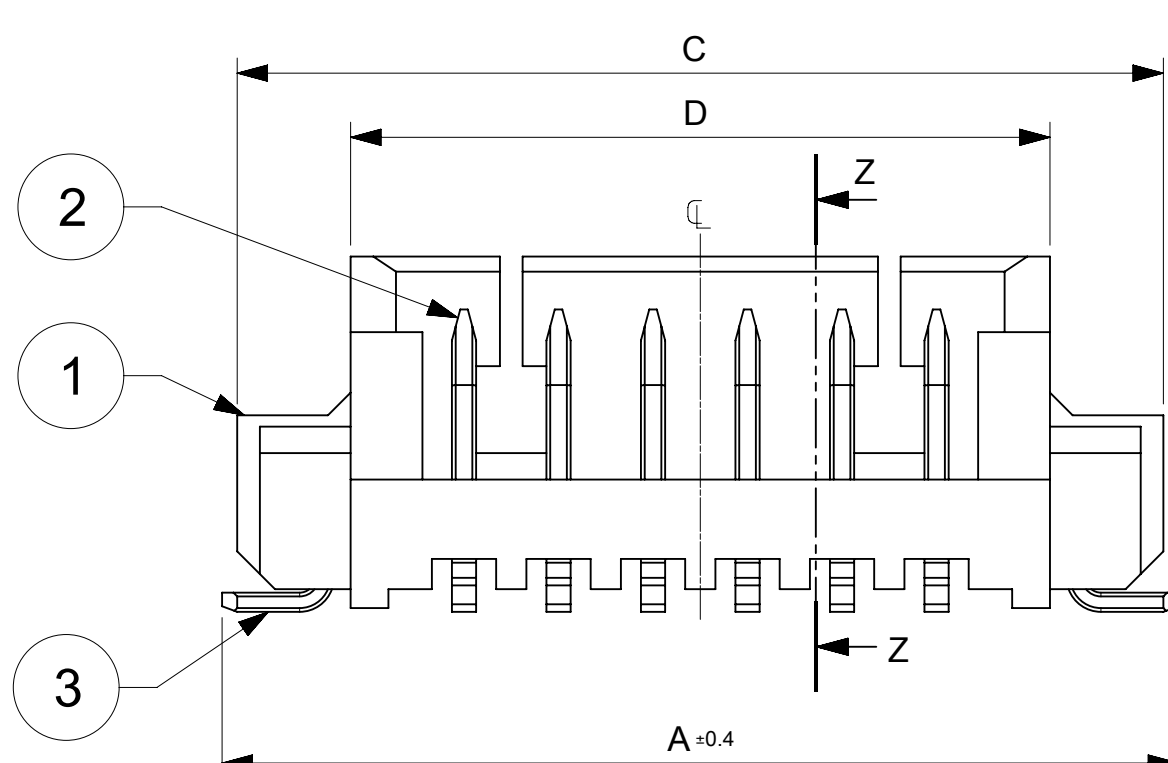


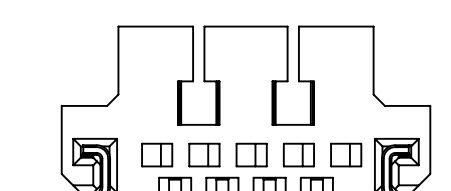


NOTES

- 材料および仕上げ（めっき仕様）：TABLE 1参照
MATERIAL AND FINISHES : SEE TABLE 1
- 適用製品及び各種仕様書はSHEET 4を参照のこと
REFER TO SHEET 4 ABOUT APPLICABLE PRODUCTS AND VARIOUS SPECIFICATIONS
- 梱包形態：SHEET 3 参照
PACKAGING INFOMATION : SEE SHEET 3
- 本製品は金めっき品です。錫めっき品は533980000-SDをご参照ください
THIS PRODUCT IS GOLD PLATING TYPE.
PLEASE REFER TO 533980000-SD FOR TIN PLATING TYPE.
- 端子テール部およびネイルの平坦度は0.1以下
COPLANARITY OF TAIL AND NAIL TO BE 0.1 MAX.
- 水平面上においてのハウジング底面 **W** とソルダーテール及びネイル底面とのズレ量を示す。
MISALIGNMENT OF SOLDER TAIL AND NAIL FROM **W**
- 偶数極のみに適用
APPLY TO EVEN CIRCUIT PRODUCTS.



2, 3極形状 (1ロック)
FIGURE OF 2, 3 CIRCUIT (1 LOCK)



4~15極形状 (2ロック)
FIGURE OF 4-15 CIRCUIT (2 LOCKS)

18.6	19.3	20.5	23.5	17.5	23.9	15
17.35	18.05	19.25	22.25	16.25	22.65	14
16.1	16.8	18	21	15	21.4	13
14.85	15.55	16.75	19.75	13.75	20.15	12
13.6	14.3	15.5	18.5	12.5	18.9	11
12.35	13.05	14.25	17.25	11.25	17.65	10
11.1	11.8	13	16	10	16.4	9
9.85	10.55	11.75	14.75	8.75	15.15	8
8.6	9.3	10.5	13.5	7.5	13.9	7
7.35	8.05	9.25	12.25	6.25	12.65	6
6.1	6.8	8	11	5	11.4	5
4.85	5.55	6.75	9.75	3.75	10.15	4
3.6	4.3	5.5	8.5	2.5	8.9	3
2.35	3.05	4.25	7.25	1.25	7.65	2
F	E	D	C	B	A	極数 CIRCUIT SIZE

①

TABLE 1

番号 NO.	部品 PART	材質 MATERIAL	
①	ハウジング HOUSING	ポリアミド(PA), UL94V-0, GLASS-FILLED, 色: ナチュラル(ベージュ) POLYAMIDE(PA), UL94V-0, GLASS-FILLED, COLOR: NATURAL (BEIGE)	
②	ターミナル TERMINAL	母材 MATERIAL	りん青銅 PHOSPHOR BRONZE
		コンタクト部 CONTACT AREA	金めっき : めっき厚は注記15参照 GOLD PLATING PLATING THICKNESS : SEE NOTE 15.
		テール部 TAIL AREA	金めっき GOLD PLATING
		下地めっき UNDER PLATING	ニッケルめっき 1.0 micro-meters MIN NICKEL PLATING 1.0 micro-meters MIN
③	ネイル NAIL	母材 MATERIAL	りん青銅 PHOSPHOR BRONZE
		テール部 TAIL AREA	無光沢錫めっき 1.0 micro-meters MIN MATTE TIN PLATING 1.0 micro-meters MIN
		下地めっき UNDER PLATING	ニッケルめっき 1.0 micro-meters MIN NICKEL PLATING 1.0 micro-meters MIN

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS		SCALE	CURRENT REV DESC:				molex		
mm		NTS							
GENERAL TOLERANCES (UNLESS SPECIFIED)									
ANGULAR TOL		± 3.0 °							
4 PLACES		± 0.2					EC NO: 744677		
3 PLACES		± 0.2	DRWN: QHE31				2022/06/13		
2 PLACES		± 0.2	CHK'D: AIDA				2023/07/24		
1 PLACE		± 0.2	APPR: MARAI				2023/07/24		
0 PLACES		± 0.2	INITIAL REVISION:				DOCUMENT NUMBER		
			DRWN: QHE31				533980002-SD		
			APPR: KOMURAKAMI				DOC TYPE		
							PSD		
							DOC PART		
							REVISION		
							B		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING	SERIES	MATERIAL NUMBER		CUSTOMER		SHEET NUMBER
			A2-SIZE	53398	SEE CHART OF SHEET3		GENERAL		1 OF 4

molex

PICOBLEAD 1.25
HEADER ASSY SMT VERTICAL GOLD PLATING TYPE

PRODUCT CUSTOMER DRAWING

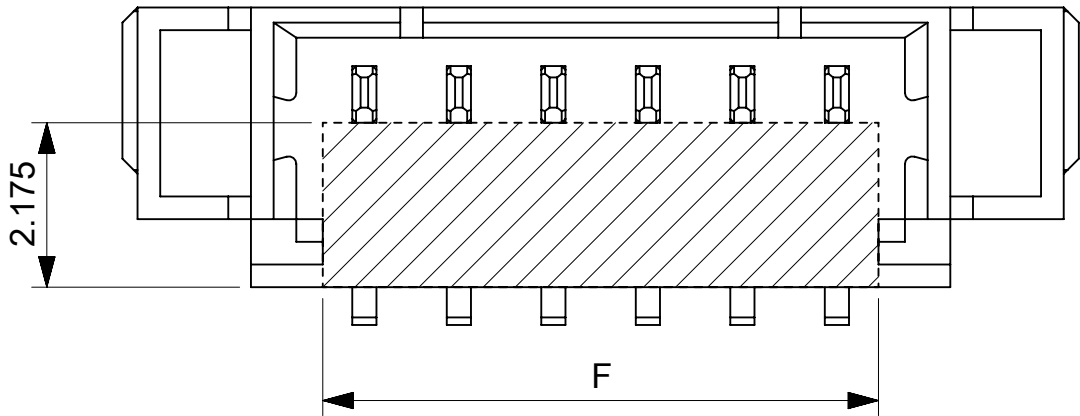
DOCUMENT NUMBER
533980002-SD

DOC TYPE
PSD

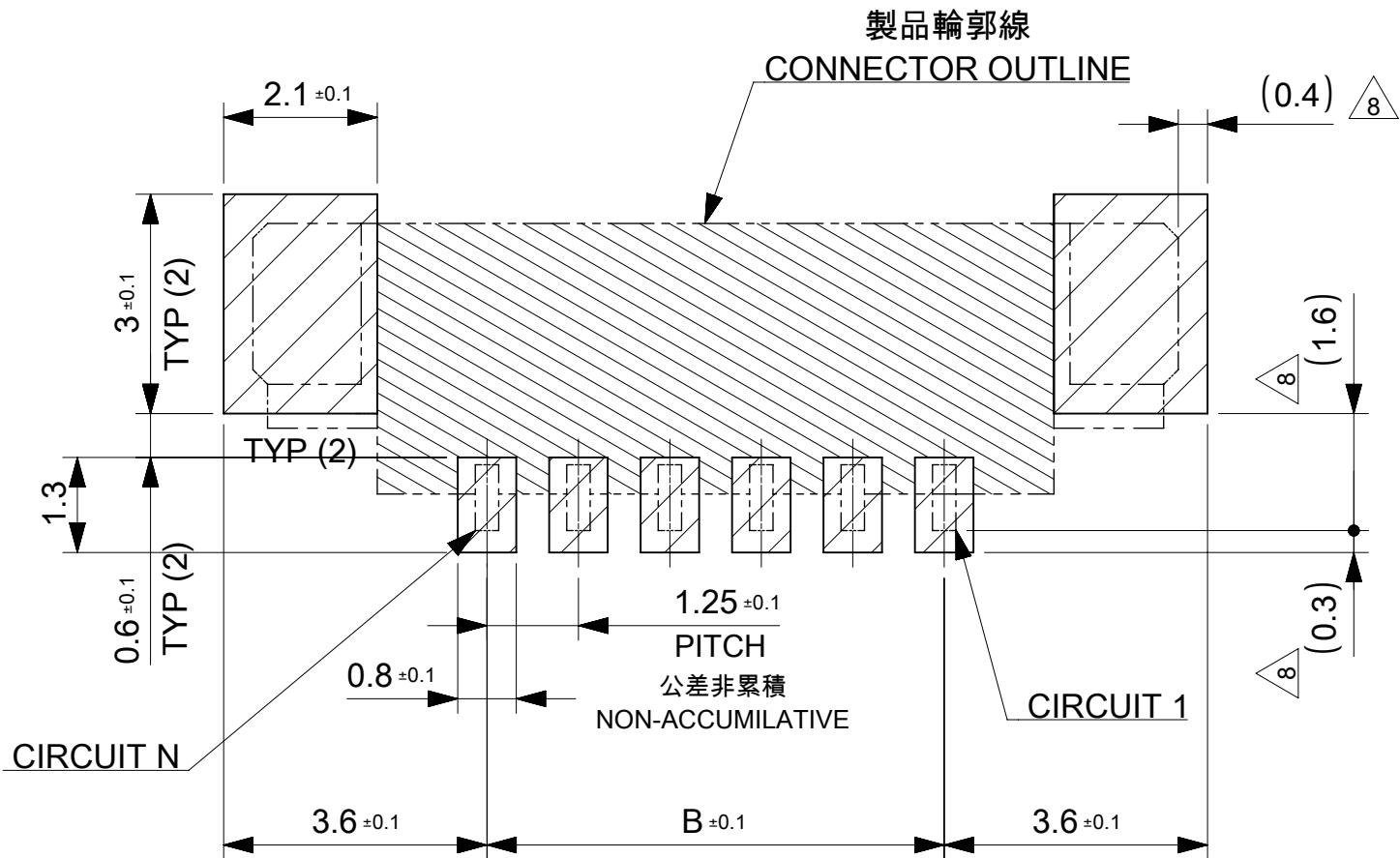
DOC PART
000

REVISION
B

DOCUMENT STATUS	P1	RELEASE DATE	2023/07/24	10:03:44
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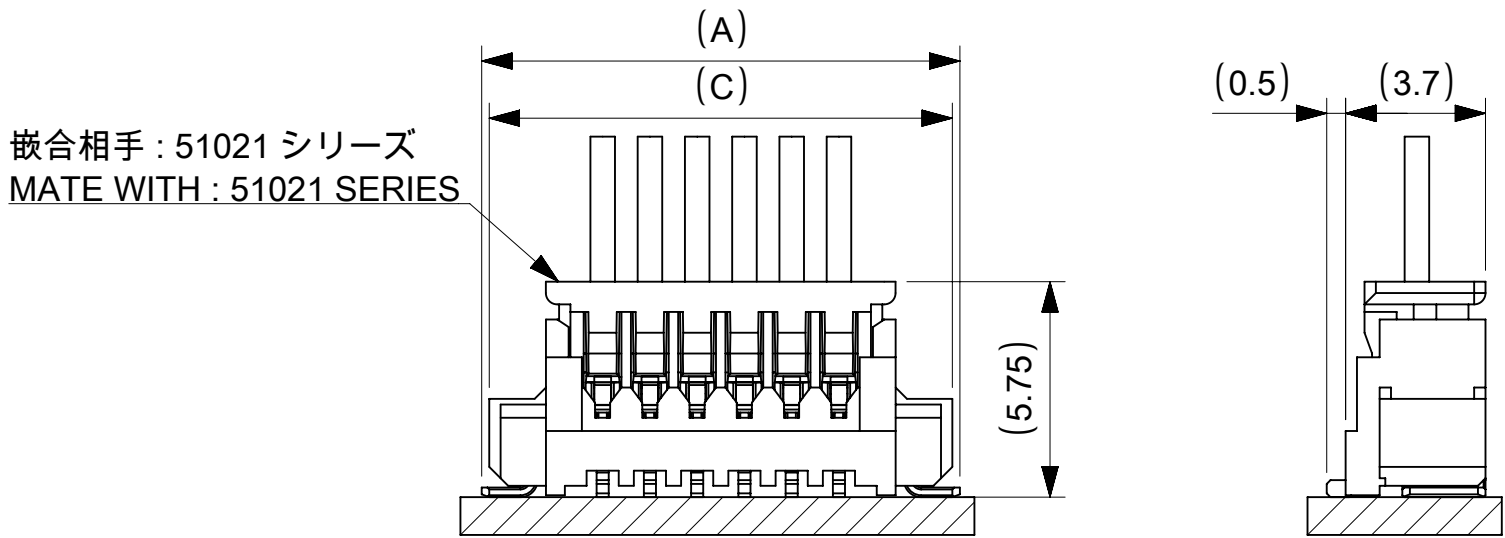
吸着面
VACUUM AREA



推奨基板レイアウト (実装面側)
RECOMMENDED PCB LAYOUT : COMPONENT SIDE

(参考 : 基板厚 1.0 MILLIMETER, メタルマスク厚さ: 0.15 MILLIMETER, マスク開口率:100%)
(REFERENCE : PCB THICKNESS 1.0 MILLIMETER, STENCIL THICKNESS: 0.15 MILLIMETER, APERTURE:100%)

パターン非推奨エリア
PATTERN NOT RECOMMENDED AREA



嵌合図
MATED CONNECTORS

- △₈ コネクタ外形からパッドまでの寸法を示す。
DIMENSIONS FROM CONNECTOR OUTLINE TO PAD
- △₉ 製品の基板実装部以外の金属露出部と基板パターンとの干渉、
および製品と基板上の突起物との干渉が生じないようにご配慮をお願いいたします。
PLEASE TAKE CARE NOT TO CAUSE INTERFERENCE BETWEEN EXPOSED
METAL PARTS EXCLUDING MOUNTING PORTION OF PRODUCT AND PWB PATTERN,
AND INTERFERENCE BETWEEN PRODUCT AND PROTRUSIONS ON PWB.

18.6	19.3	20.5	23.5	17.5	23.9	15
17.35	18.05	19.25	22.25	16.25	22.65	14
16.1	16.8	18	21	15	21.4	13
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F	E	D	C	B	A	極数 CIRCUIT SIZE

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DIMENSION UNITS	SCALE	CURRENT REV DESC:	
mm	NTS		
GENERAL TOLERANCES (UNLESS SPECIFIED)			
ANGULAR TOL	± 3.0 °		
4 PLACES	± 0.2		
3 PLACES	± 0.2		
2 PLACES	± 0.2		
1 PLACE	± 0.2		
0 PLACES	± 0.2		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING

EC NO: 744677
DRWN: QHE31
CHK'D: AIDA
APPR: MARAI

2022/06/13
2023/07/24
2023/07/24

INITIAL REVISION:
DRWN: QHE31
APPR: KOMURAKAMI

2020/08/03
2021/05/27

molex

PICOBLADE 1.25
HEADER ASSY SMT VERTICAL GOLD PLATING TYPE

PRODUCT CUSTOMER DRAWING

DOCUMENT NUMBER	DOC TYPE	DOC PART	REVISION
533980002-SD	PSD	000	B
MATERIAL NUMBER	CUSTOMER	SHEET NUMBER	
SEE CHART OF SHEET3	GENERAL	2 OF 4	

DOCUMENT STATUS	P1	RELEASE DATE	2023/07/24	10:03:44
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